**EVALUATION KIT** INFORMATION INCLUDED

# **MAX786**

### **Dual-Output Power-Supply** Controller for Notebook Computers

### **General Description**

The MAX786 is a system-engineered power-supply controller for notebook computers or similar batterypowered equipment. It provides two high-performance step-down (buck) pulse-width modulators (PWMs) for +3.3V and +5V. Other features include dual, low-dropout, micropower linear regulators for CMOS/RTC back-up, and two precision low-batterydetection comparators.

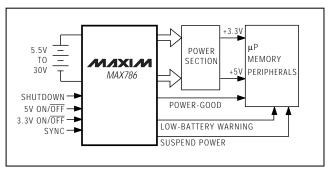
High efficiency (95% at 2A; greater than 80% at loads from 5mA to 3A) is achieved through synchronous rectification and PWM operation at heavy loads, and Idle Mode™ operation at light loads. The MAX786 uses physically small components, thanks to high operating frequencies (300kHz/200kHz) and a new current-mode PWM architecture that allows for output filter capacitors as small as 30µF per ampere of load. Line- and loadtransient responses are terrific, with a high 60kHz unitygain crossover frequency allowing output transients to be corrected within four or five clock cycles. Low system cost is achieved through a high level of integration and the use of low-cost, external N-channel MOSFETs.

Other features include low-noise, fixed-frequency PWM operation at moderate to heavy loads, and a synchronizable oscillator for noise-sensitive applications such as electromagnetic pen-based systems and communicating computers. The MAX786 is a monolithic, BiCMOS IC available in fine-pitch, surface-mount SSOP packages.

### **Applications**

**Notebook Computers** Portable Data Terminals **Communicating Computers** Pen-Entry Systems

### Typical Application Diagram



### **Features**

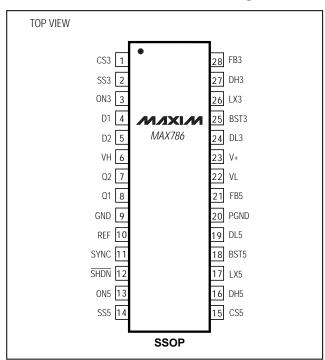
- ◆ Dual PWM Buck Controllers (+3.3V and +5V)
- **♦** Two Precision Comparators or Level Translators
- ♦ 95% Efficiency
- ♦ 420µA Quiescent Current, 70µA in Standby (linear regulators alive)
- **♦** 25µA Shutdown Current (+5V linear alive)
- ♦ 5.5V to 30V Input Range
- **♦ Small SSOP Package**
- **♦ Fixed Output Voltages:** 
  - 3.3V (standard)
  - 3.45V (High-Speed Pentium™)
  - 3.6V (PowerPC™)

### Ordering Information

| PART       | TEMP. RANGE  | PIN-PACKAGE | Vout  |
|------------|--------------|-------------|-------|
| MAX786CAI  | 0°C to +70°C | 28 SSOP     | 3.3V  |
| MAX786RCAI | 0°C to +70°C | 28 SSOP     | 3.45V |

Ordering Information continued at end of data sheet.

### Pin Configuration



Idle Mode is a trademark of Maxim Integrated Products. Pentium is a trademark of Intel Corp. PowerPC is a trademark of IBM Corp.

MIXIM

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### **ABSOLUTE MAXIMUM RATINGS**

| V+ to GND                          |                       |
|------------------------------------|-----------------------|
| VL to GND                          |                       |
| BST3, BST5 to GND                  | 0.3V to 36V           |
| LX3 to BST3                        | 7V to 0.3V            |
| LX5 to BST5                        | 7V to 0.3V            |
| Inputs/Outputs to GND              |                       |
| (D1, D2, SHDN, ON5, REF, SS5, CS5, |                       |
| FB5, SYNC, CS3,FB3, SS3, ON3)      | 0.3V to $(VL + 0.3V)$ |
| VH to GND                          | 0.3V to 20V           |
| Q1, Q2 to GND                      | 0.3V to $(VH + 0.3V)$ |
| DL3, DL5 to PGND                   | 0.3V to (VL + 0.3V)   |
|                                    |                       |

| DH3 to LX3                                     | 0.3V to (BST3 + 0.3V) |
|--|-----------------------|
| DH5 to LX5                                     | 0.3V to (BST5 + 0.3V) |
| REF, VL Short to GND                           | Momentary             |
| REF Current                                    | 20mÅ                  |
| VL Current                                     | 50mA                  |
| Continuous Power Dissipation (T <sub>A</sub> = | +70°C)                |
| SSOP (derate 9.52mW/°C above                   | +70°C)762mW           |
| Operating Temperature Ranges                   |                       |
| MAX786CAI/MAX786_CAI                           | 0°C to +70°C          |
| MAX786EAI/MAX786_EAI                           | 40°C to +85°C         |
| Lead Temperature (soldering, 10sec             | c)+300°C              |
|  |                       |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

(V+ = 15V, GND = PGND = 0V,  $I_{VL}$  =  $I_{REF}$  = 0mA,  $\overline{SHDN}$  = ON3 = ON5 = 5V, other digital input levels are 0V or +5V,  $T_A$  =  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.)

| PARAMETER   | CONDITIONS   |                                    | MIN  | TYP  | MAX  | UNITS |
|---|--|------------------------------------|------|------|------|-------|
| 3.3V AND 5V STEP-DOWN COI                             | NTROLLERS  |                                    | •    |      |      |       |
| Input Supply Range                                    |  |                                    | 5.5  |      | 30   | V     |
| FB5 Output Voltage                                    | 0mV < (CS5-FB5) < 70mV, 6V < V + < 30V (includes load and line regulation) |                                    | 4.80 | 5.08 | 5.20 | V     |
|   | 0 1/ (000 FP0) 70 1/ (1/ 1/ 001/   | MAX786                             |      | 3.35 | 3.46 |       |
| FB3 Output Voltage                                    | 0mV < (CS3-FB3) < 70mV, 6V < V + < 30V (includes load and line regulation) | MAX786R                            | 3.32 | 3.50 | 3.60 | V     |
|   | (includes load and line regulation)  | MAX786S                            | 3.46 | 3.65 | 3.75 |       |
| Load Regulation                                       | Either controller (CSFB_ = 0mV to 70mV)                                    |                                    |      | 2.5  |      | %     |
| Line Regulation                                       | Either controller (V+ = 6V to 30V)   |                                    |      | 0.03 |      | %/V   |
| Current-Limit Voltage                                 | CS3-FB3 or CS5-FB5   |                                    | 80   | 100  | 120  | mV    |
| SS3/SS5 Source Current                                |  |                                    |      | 4.0  | 6.5  | μΑ    |
| SS3/SS5 Fault Sink Current                            |  |                                    | 2    |      |      | mA    |
| INTERNAL REGULATOR AND                                | REFERENCE  |                                    | •    |      |      |       |
| VL Output Voltage                                     | ON5 = ON3 = 0V, 5.5V < V+ < 30V, 0mA < I <sub>L</sub> < 25mA               |                                    | 4.5  |      | 5.5  | V     |
| VL Fault Lockout Voltage                              | Falling edge, hysteresis = 1%  |                                    | 3.6  |      | 4.2  | V     |
| VL/FB5 Switchover Voltage                             | Rising edge of FB5, hysteresis = 1%  |                                    | 4.2  |      | 4.7  | V     |
| REF Output Voltage                                    | No external load (Note 1)  | No external load (Note 1)          |      |      | 3.36 | V     |
| REF Fault Lockout Voltage                             | Falling edge   |                                    | 2.4  |      | 3.2  | V     |
| REF Load Regulation                                   | 0mA < I <sub>L</sub> < 5mA (Note 2)  |                                    |      | 30   | 75   | mV    |
| V+ Shutdown Current                                   | SHDN = D1 = D2 = ON3 = ON5 = 0V, V+ =                                      | 30V                                |      | 25   | 40   | μA    |
| V+ Standby Current                                    | D1 = D2 = ON3 = ON5 = 0V, V+ = 30V   | D1 = D2 = ON3 = ON5 = 0V, V+ = 30V |      | 70   | 120  | μA    |
| Quiescent Power Consumption (both PWM controllers on) | D1 = D2 = 0V, FB5 = CS5 = 5.25V,<br>FB3 = CS3 = 3.5V                       |                                    |      | 5.5  | 8.6  | mW    |
| V+ Off Current  | FB5 = CS5 = 5.25V, VL switched over to FB5                                 |                                    |      | 30   | 60   | μA    |
| COMPARATORS   | 1  |                                    | 1    |      |      |       |
| D1, D2 Trip Voltage                                   | Falling edge, hysteresis = 1%  |                                    | 1.61 |      | 1.69 | V     |
| D1, D2 Input Current                                  | D1 = D2 = 0V, 5V   |                                    |      |      | ±100 | nA    |

### **ELECTRICAL CHARACTERISTICS (continued)**

(V+ = 15V, GND = PGND = 0V,  $I_{VL} = I_{REF} = 0$ mA,  $\overline{SHDN} = 0$ N3 = 0N5 = 5V, other digital input levels are 0V or +5V,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.)

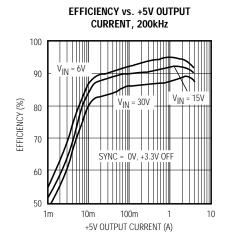
| PARAMETER                   | CONDITIONS  | MIN      | TYP | MAX  | UNITS |  |
|-----------------------------|---|----------|-----|------|-------|--|
| Q1, Q2 Source Current       | VH = 15V, V <sub>OUT</sub> = 2.5V                 | 12       | 20  | 30   | μA    |  |
| Q1, Q2 Sink Current         | VH = 15V, V <sub>OUT</sub> = 2.5V                 | 200      | 500 | 1000 | μA    |  |
| Q1, Q2 Output High Voltage  | $I_{SOURCE} = 5\mu A$ , VH = 3V                   | VH -0.5  |     |      | V     |  |
| Q1, Q2 Output Low Voltage   | $I_{SINK} = 20\mu A$ , VH = 3V                    |          |     | 0.4  | V     |  |
| Quiescent VH Current        | VH = 18V, D1 = D2 = 5V, no external load          |          | 4   | 10   | μA    |  |
| OSCILLATOR AND INPUTS/OU    | JTPUTS  |          |     |      |       |  |
| Oscillator Frequency        | SYNC = 3.3V                                       | 270      | 300 | 330  | - kHz |  |
| Oscillator Frequency        | SYNC = 0V, 5V                                     | 170      | 200 | 230  | - KHZ |  |
| SYNC High Pulse Width       |   | 200      |     |      | ns    |  |
| SYNC Low Pulse Width        |   | 200      |     |      | ns    |  |
| SYNC Rise/Fall Time         | Not tested  |          |     | 200  | ns    |  |
| Oscillator SYNC Range       |   | 240      |     | 350  | kHz   |  |
| Maximum Duty Cycle          | SYNC = 3.3V                                       | 89       | 92  |      | - %   |  |
| Waximum Duty Cycle          | SYNC = 0V or 5V                                   | 92       | 95  |      |       |  |
| Input Low Voltage           | SHDN, ON3, ON5, SYNC                              |          |     | 0.8  | V     |  |
| Input High Voltage          | SHDN, ON3, ON5                                    | 2.4      |     |      | V     |  |
| Input rigit voltage         | SYNC  | VL - 0.5 |     |      | _ v   |  |
| Input Current               | SHDN, ON3, ON5 V <sub>IN</sub> = 0V, 5V           |          |     | ±1   | μΑ    |  |
| DL3/DL5 Sink/Source Current | V <sub>OUT</sub> = 2V                             |          | 1   |      | А     |  |
| DH3/DH5 Sink/Source Current | BST3-LX3 = BST5-LX5 = 4.5V, V <sub>OUT</sub> = 2V |          | 1   |      | А     |  |
| DL3/DL5 On-Resistance       | High or low                                       |          |     | 7    | Ω     |  |
| DH3/DH5 On-Resistance       | High or low, BST3-LX3 = BST5-LX5 = 4.5V           |          |     | 7    | Ω     |  |

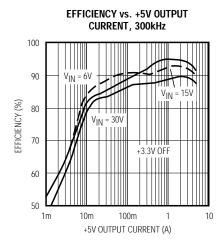
Note 1: Since the reference uses VL as its supply, its V+ line regulation error is insignificant.

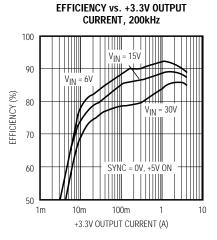
Note 2: The main switching outputs track the reference voltage. Loading the reference reduces the main outputs slightly according to the closed-loop gain (AV<sub>CL</sub>) and the reference voltage load-regulation error. AV<sub>CL</sub> for the +3.3V supply is unity gain. AV<sub>CL</sub> for the +5V supply is 1.54.

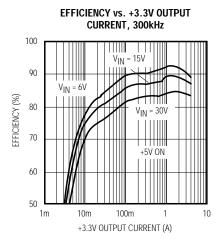
### Typical Operating Characteristics

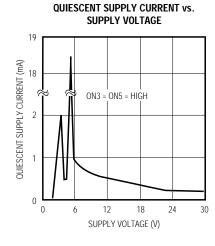
(Circuit of Figure 1,  $T_A = +25$ °C, unless otherwise noted.)

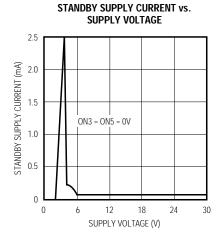


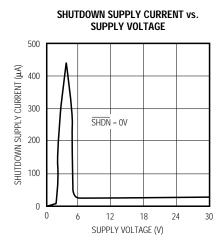


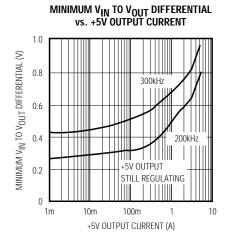


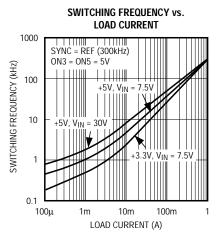












### Typical Operating Characteristics (continued)

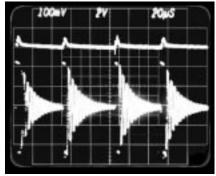
(Circuit of Figure 1,  $T_A = +25$ °C, unless otherwise noted.)

+5V OUTPUT

50mV/div

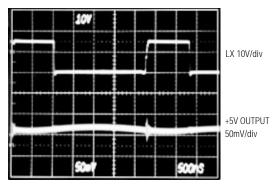
2V/div

### **IDLE MODE WAVEFORMS**



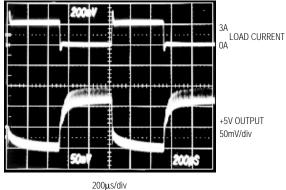
200µs/div I<sub>LOAD</sub> = 100mA V<sub>IN</sub> = 10V

### PULSE-WIDTH MODULATION MODE WAVEFORMS



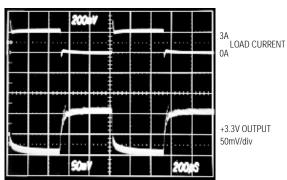
 $500 ns/div \\ +5V OUTPUT CURRENT = 1A \\ V_{IN} = 16V$ 

#### +5V LOAD-TRANSIENT RESPONSE



 $200\mu s/\text{div} \\ V_{IN} = 15 V$ 

#### +3.3V LOAD-TRANSIENT RESPONSE

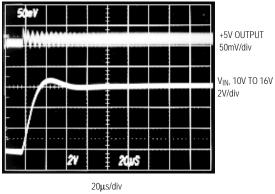


 $200\mu s/\text{div} \\ V_{IN} = 15 V$ 

### Typical Operating Characteristics (continued)

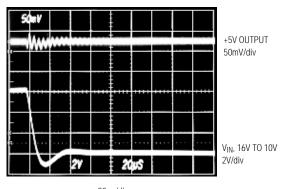
(Circuit of Figure 1,  $T_A = +25$ °C, unless otherwise noted.)

#### +5V LINE-TRANSIENT RESPONSE, RISING



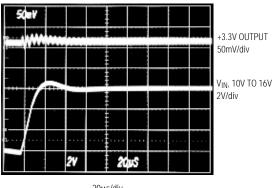
 $I_{LOAD} = 2A$ 

### +5V LINE-TRANSIENT RESPONSE, FALLING



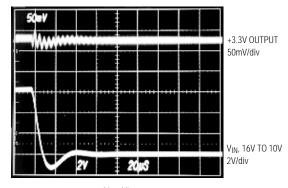
 $20\mu s/div$  $I_{LOAD} = 2A$ 

#### +3.3V LINE-TRANSIENT RESPONSE, RISING



20µs/div I<sub>LOAD</sub> = 2A

#### +3.3V LINE-TRANSIENT RESPONSE, FALLING



 $20\mu s/div$  $I_{LOAD} = 2A$ 

### Pin Description

| PIN | NAME | FUNCTION  |  |
|-----|------|---|--|
| 1   | CS3  | Current-sense input for +3.3V; +100mV = current limit level referenced to FB3.  |  |
| 2   | SS3  | soft-start input for +3.3V. Ramp time to full current limit is 1ms/nF of capacitance to GND.  |  |
| 3   | ON3  | ON/OFF control input disables the +3.3V PWM. Tie directly to VL for automatic start-up.   |  |
| 4   | D1   | #1 level-translator/comparator noninverting input, threshold = +1.650V. Controls Q1. Tie to GND if unused.  |  |
| 5   | D2   | #2 level-translator/comparator noninverting input (see D1)  |  |
| 6   | VH   | External positive supply-voltage input for the level translators/comparators  |  |
| 7   | Q2   | #2 level-translator/comparator output. Sources $20\mu A$ from VH when D2 is high. Sinks $500\mu A$ to GND when D2 is low, even with VH = 0V.  |  |
| 8   | Q1   | #1 level translator/comparator output (see Q2)  |  |
| 9   | GND  | Low-current analog ground   |  |
| 10  | REF  | 3.3V reference output. Sources up to 5mA for external loads. Bypass to GND with 1µF/mA of load or 0.22µF minimum.   |  |
| 11  | SYNC | Oscillator control/synchronization input. Connect to VL or GND for 200kHz; connect to REF for 300kHz. For external clock synchronization in the 240kHz to 350kHz range, a high-to-low transition causes a new cycle to start. |  |
| 12  | SHDN | Shutdown control input, active low. Tie to VL for automatic start-up. The 5V VL supply stays active in shutdown, but all other circuitry is disabled. Do not force SHDN higher than VL + 0.3V.                                |  |
| 13  | ON5  | ON/OFF control input disables the +5V PWM supply. Tie to VL for automatic start-up.   |  |
| 14  | SS5  | Soft-start control input for +5V. Ramp time to full current limit is 1ms/nF of capacitance to GND.  |  |
| 15  | CS5  | Current-sense input for +5V; +100mV = current-limit level referenced to FB5.  |  |
| 16  | DH5  | Gate-drive output for the +5V high-side MOSFET  |  |
| 17  | LX5  | Inductor connection for the +5V supply  |  |
| 18  | BST5 | Boost capacitor connection for the +5V supply (0.1µF)   |  |
| 19  | DL5  | Gate-drive output for the +5V low-side MOSFET   |  |
| 20  | PGND | Power ground  |  |
| 21  | FB5  | Feedback and current-sense input for the +5V PWM  |  |
| 22  | VL   | 5V logic supply voltage for internal circuitry. VL is always on and can source 5mA for external loads.  |  |
| 23  | V+   | Supply voltage input from battery, 5.5V to 30V  |  |
| 24  | DL3  | Gate-drive output for the +3.3V low-side MOSFET   |  |
| 25  | BST3 | Boost capacitor connection for the +3.3V supply (0.1µF)   |  |
| 26  | LX3  | nductor connection for the +3.3V supply   |  |
| 27  | DH3  | Gate-drive output for the +3.3V high-side MOSFET  |  |
| 28  | FB3  | Feedback and current-sense input for the +5V PWM  |  |

### \_Detailed Description

The MAX786 converts a 5.5V to 30V input to four outputs (Figure 1). It produces two high-power, PWM, switch-mode supplies, one at +5V and the other at +3.3V. The two supplies operate at either 300kHz or 200kHz, allowing for small external components. Output current capability depends on external components, and can exceed 6A on each supply. An internal 5V, 5mA supply (VL) and a 3.3V, 5mA reference voltage are also generated via linear regulators, as shown in Figure 2. Fault protection circuitry shuts off the PWMs when the internal supplies lose regulation.

Two precision voltage comparators are also included. Their output stages permit them to be used as level translators for driving external N-channel MOSFETs in load-switching applications, or for more conventional logic signals.

The MAX786 has two close relatives: the MAX782 and the MAX783. The MAX782 and MAX783 each include an extra flyback winding regulator and linear regulators for dual, +12V/programmable PCMCIA VPP outputs. The MAX782/MAX783 data sheet contains extra applications information on the MAX786 not found in this data sheet.

### +3.3V Switch-Mode Supply

The +3.3V supply is generated by a current-mode, PWM step-down regulator using two N-channel MOSFETs, a rectifier, and an LC output filter (Figure 1). The gate-drive signal to the high-side MOSFET, which must exceed the battery voltage, is provided by a boost circuit that uses a 100nF capacitor connected to BST3.

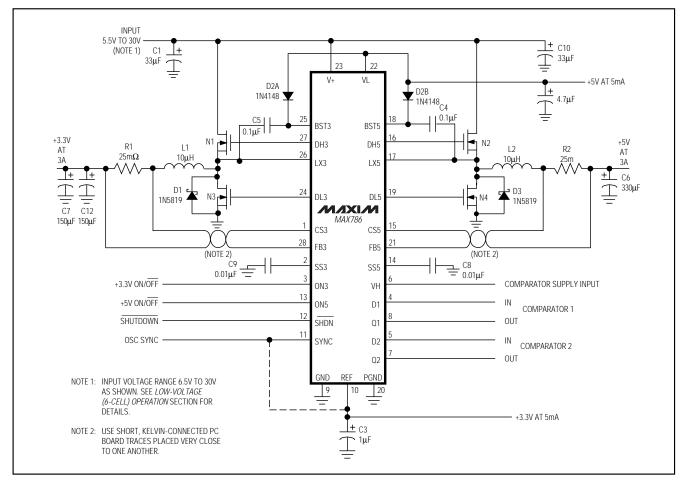


Figure 1. MAX786 Application Circuit

A synchronous rectifier at LX3 keeps efficiency high by clamping the voltage across the rectifier diode. Maximum current limit is set by an external low-value sense resistor, which prevents excessive inductor current during start-up or under short-circuit conditions.

Programmable soft-start is set by an optional external capacitor; this reduces in-rush surge currents upon start-up and provides adjustable power-up times for power-supply sequencing purposes.

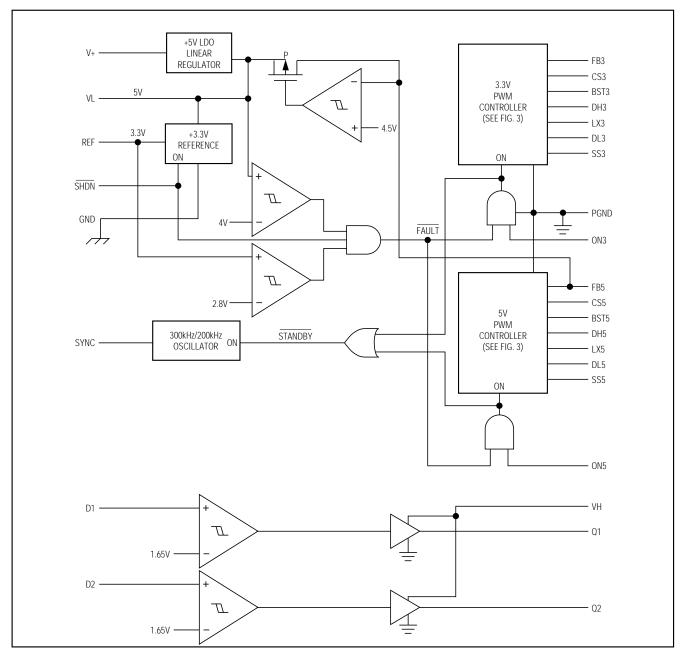


Figure 2. MAX786 Block Diagram

### +5V Switch-Mode Supply

The +5V output is produced by a current-mode, PWM step-down regulator, which is nearly identical to the +3.3V supply. The +5V supply's dropout voltage, as configured in Figure 1, is typically 400mV at 2A. As V+ approaches 5V, the +5V output gracefully falls with V+ until the VL regulator output hits its undervoltage-lockout threshold at 4V. At this point, the +5V supply turns off.

The default frequency for both PWM controllers is 300kHz (with SYNC connected to REF), but 200kHz may be used by connecting SYNC to GND or VL.

### +3.3V and +5V PWM Buck Controllers

The two current-mode PWM controllers are identical except for different preset output voltages (Figure 3). Each PWM is independent except for being synchronized to a master oscillator and sharing a common reference (REF) and logic supply (VL). Each PWM can be turned on and off separately via ON3 and ON5. The PWMs are a direct-summing type, lacking a traditional integrator error amplifier and the phase shift associated with it. They therefore do not require any external feedback compensation components if the filter capacitor ESR guidelines given in the *Design Procedure* are followed.

The main gain block is an open-loop comparator that sums four input signals: an output voltage error signal, current-sense signal, slope-compensation ramp, and precision voltage reference. This direct-summing method approaches the ideal of cycle-by-cycle control of the output voltage. Under heavy loads, the controller operates in full PWM mode. Every pulse from the oscillator sets the output latch and turns on the high-side switch for a period determined by the duty cycle (approximately V<sub>OUT</sub>/V<sub>IN</sub>). As the high-side switch turns off, the synchronous rectifier latch is set and, 60ns later, the low-side switch turns on (and stays on until the beginning of the next clock cycle, in continuous mode, or until the inductor current crosses through zero, in discontinuous mode). Under fault conditions where the inductor current exceeds the 100mV current-limit threshold, the high-side latch is reset and the high-side switch is turned off.

At light loads, the inductor current fails to exceed the 25mV threshold set by the minimum current comparator. When this occurs, the PWM goes into idle mode, skipping most of the oscillator pulses in order to reduce the switching frequency and cut back switching losses. The oscillator is effectively gated off at light loads because the minimum current comparator immediately resets the high-side latch at the beginning of each cycle, unless the FB\_ signal falls below the reference voltage level.

#### Soft-Start/SS\_ Inputs

Connecting capacitors to SS3 and SS5 allows gradual build-up of the +3.3V and +5V supplies after ON3 and ON5 are driven high. When ON3 or ON5 is low, the appropriate SS capacitors are discharged to GND. When ON3 or ON5 is driven high, a 4µA constant current source charges these capacitors up to 4V. The resulting ramp voltage on the SS\_ pins linearly increases the current-limit comparator setpoint so as to increase the duty cycle to the external power MOSFETs up to the maximum output. With no SS capacitors, the circuit will reach maximum current limit within 10µs.

Soft-start greatly reduces initial in-rush current peaks and allows start-up time to be programmed externally.

#### Synchronous Rectifiers

Synchronous rectification allows for high efficiency by reducing the losses associated with the Schottky rectifiers.

When the external power MOSFET N1 (or N2) turns off, energy stored in the inductor causes its terminal voltage to reverse instantly. Current flows in the loop formed by the inductor, Schottky diode, and load—an action that charges up the filter capacitor. The Schottky diode has a forward voltage of about 0.5V which, although small, represents a significant power loss, degrading efficiency. A synchronous rectifier, N3 (or N4), parallels the diode and is turned on by DL3 (or DL5) shortly after the diode conducts. Since the on resistance (r<sub>DS(ON)</sub>) of the synchronous rectifier is very low, the losses are reduced.

The synchronous rectifier MOSFET is turned off when the inductor current falls to zero.

Cross conduction (or "shoot-through") occurs if the high-side switch turns on at the same time as the synchronous rectifier. The MAX786's internal break-beforemake timing ensures that shoot-through does not occur. The Schottky rectifier conducts during the time that neither MOSFET is on, which improves efficiency by preventing the synchronous-rectifier MOSFET's lossy body diode from conducting.

The synchronous rectifier works under all operating conditions, including discontinuous-conduction and idle mode.

#### **Boost Gate-Driver Supply**

Gate-drive voltage for the high-side N-channel switch is generated with a flying-capacitor boost circuit as shown in Figure 4. The capacitor is alternately charged from the VL supply via the diode and placed in parallel with the high-side MOSFET's gate-source terminals. On startup, the synchronous rectifier (low-side) MOSFET forces LX\_ to 0V and charges the BST\_ capacitor to 5V. On the

second half-cycle, the PWM turns on the high-side MOSFET by connecting the capacitor to the MOSFET gate by closing an internal switch between BST\_ and DH\_. This provides the necessary enhancement voltage to turn on the high-side switch, an action that "boosts" the 5V gate-drive signal above the battery voltage.

Ringing seen at the high-side MOSFET gates (DH3 and DH5) in discontinuous-conduction mode (light loads) is a natural operating condition caused by the residual energy in the tank circuit formed by the inductor and stray capacitance at the LX\_ nodes. The gate driver negative rail is referred to LX\_, so any ringing there is directly coupled to the gate-drive supply.

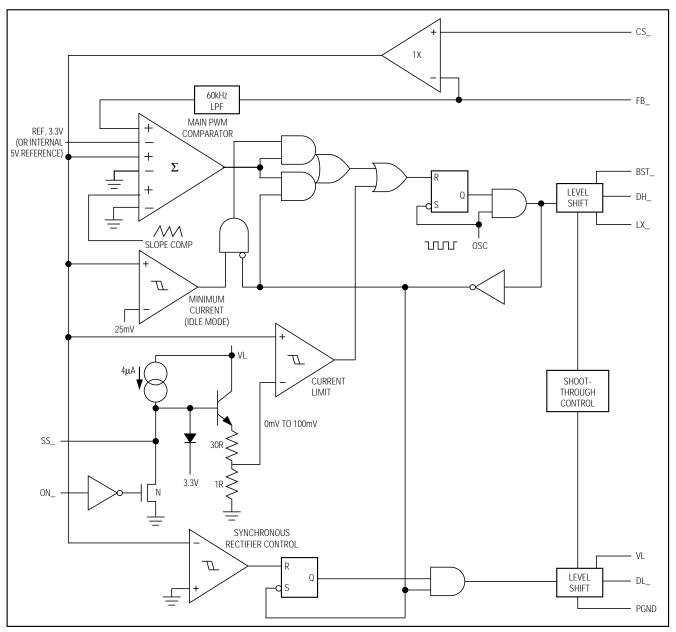


Figure 3. PWM Controller Block Diagram

### Modes of Operation PWM Mode

Under heavy loads—over approximately 25% of full load—the +3.3V and +5V supplies operate as continuous-current PWM supplies (see *Typical Operating Characteristics*). The duty cycle (%ON) is approximately:

$$\%ON = V_{OLIT}/V_{IN}$$

Current flows continuously in the inductor: First, it ramps up when the power MOSFET conducts; then, it ramps down during the flyback portion of each cycle as energy is put into the inductor and then discharged into the load. Note that the current flowing into the inductor when it is being charged is also flowing into the load, so the load is continuously receiving current from the inductor. This minimizes output ripple and maximizes inductor use, allowing very small physical and electrical sizes. Output ripple is primarily a function of the filter capacitor (C7 or C6) effective series resistance (ESR) and is typically under 50mV (see the *Design Procedure* section). Output ripple is worst at light load and maximum input voltage.

#### **Idle Mode**

Under light loads (<25% of full load), efficiency is further enhanced by turning the drive voltage on and off for only a single clock period, skipping most of the clock pulses entirely. Asynchronous switching, seen as "ghosting" on an oscilloscope, is thus a normal operating condition whenever the load current is less than approximately 25% of full load.

At certain input voltage and load conditions, a transition region exists where the controller can pass back and forth from idle mode to PWM mode. In this situation, short bursts of pulses occur that make the current waveform look erratic, but do not materially affect the output ripple. Efficiency remains high.

### **Current Limiting**

The voltage between CS3 (CS5) and FB3 (FB5) is continuously monitored. An external, low-value shunt resistor is connected between these pins, in series with the inductor, allowing the inductor current to be continuously measured throughout the switching cycle. Whenever this voltage exceeds 100mV, the drive voltage to the external high-side MOSFET is cut off. This protects the MOSFET, the load, and the battery in case of short circuits or temporary load surges. The current-limiting resistors R1 and R2 are typically 25m $\Omega$  for 3A load current.

#### Oscillator Frequency; SYNC Input

The SYNC input controls the oscillator frequency. Connecting SYNC to GND or to VL selects 200kHz operation; connecting to REF selects 300kHz operation. SYNC

can also be driven with an external 240kHz to 350kHz CMOS/TTL source to synchronize the internal oscillator.

Normally, 300kHz is used to minimize the inductor and filter capacitor sizes, but 200kHz may be necessary for low input voltages (see *Low-Voltage (6-Cell) Operation*).

### **Comparators**

Two noninverting comparators can be used as precision voltage comparators or high-side drivers. The supply for these comparators (VH) is brought out and may be connected to any voltage between +3V and +19V irrespective of V+. The noninverting inputs (D1-D2) are high impedance, and the inverting input is internally connected to a 1.650V reference. Each output (Q1-Q2) sources  $20\mu A$  from VH when its input is above 1.650V, and sinks  $500\mu A$  to GND when its input is below 1.650V. The Q1-Q2 outputs can be fixed together in wired-OR configuration since the pull-up current is only  $20\mu A$ .

Connecting VH to a logic supply (5V or 3V) allows the comparators to be used as low-battery detectors. For driving N-channel power MOSFETs to turn external loads on and off, VH should be 6V to 12V higher than the load voltage. This enables the MOSFETs to be fully turned on and results in low  $r_{DS(ON)}$ .

The comparators are always active when V+ is above +4V, even when VH is 0V. Thus, Q1-Q2 will sink current to GND even when VH is 0V, but they will only source current from VH when VH is above approximately 1.5V.

If Q1 or Q2 is externally pulled above VH, an internal diode conducts, pulling VH a diode drop below the output and powering anything connected to VH. This voltage will also power the other comparator outputs.

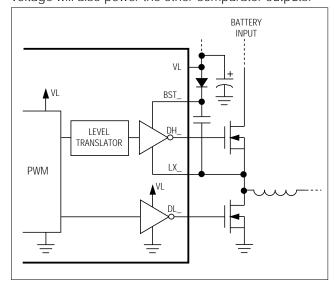


Figure 4. Boost Supply for Gate Drivers

**Table 1. Surface-Mount Components** 

(See Figure 1 for Standard Application Circuit.)

| COMPONENT | SPECIFICATION                   | MANUFACTURER          | PART NO.          |
|-----------|---------------------------------|-----------------------|-------------------|
| C1, C10   | 33µF, 35V tantalum capacitors   | AVX                   | TPSE226M035R0100  |
| 01, 010   | oopi , oo v tantalam capacitors | Sprague               | 595D336X0035R     |
| C2        | 4.7μF, 6V tantalum capacitor    | AVX                   | TAJB475M016       |
| 02        | 4.7µ1, ov tantalam capacitor    | Sprague               | 595D475X0016A     |
| C3        | 1μF, 20V tantalum capacitor     | AVX                   | TAJA105M025       |
|           | This, 200 tantalam capacitor    | Sprague               | 595D105X0020A2B   |
| C4, C5    | 0.1µF, 16V ceramic capacitors   | Murata-Erie           | GRM42-6X7R104K50V |
| C6        | 330µF, 10V tantalum capacitor   | Sprague               | 595D337X0010R     |
| C7, C12   | 150µF, 10V tantalum capacitors  | Sprague               | 595D157X0010D     |
| C8, C9    | 0.01µF, 16V ceramic capacitors  | Murata-Erie           | GRM42-6X7R103K50V |
| D2A, D2B  | 1N4148-type dual diodes         | Central Semiconductor | CMPD2836          |
| D1, D3    | 1N5819 SMT diodes               | Nihon                 | EC10QS04          |
| L1, L2    | 10μH, 2.65A inductors           | Sumida                | CDR125-100        |
| N1-N4     | N-channel MOSFETs (SO-8)        | Siliconix             | Si9410DY          |
| R1, R2    | 0.025Ω, 1% (SMT) resistors      | IRC                   | LR2010-01-R025-F  |

### **Table 2. Component Suppliers**

| COMPANY               | FACTORY FAX<br>[COUNTRY CODE] | USA PHONE                        |
|-----------------------|-------------------------------|----------------------------------|
| AVX                   | [1] (803) 626-3123            | (803) 946-0690<br>(800) 282-4975 |
| Central Semiconductor | [1] (516) 435-1824            | (516) 435-1110                   |
| IRC                   | [1] (512) 992-3377            | (512) 992-7900                   |
| Murata-Erie           | [1] (814) 238-0490            | (814) 237-1431                   |
| Nihon                 | [81] 3-3494-7414              | (805) 867-2555                   |
| Siliconix             | [1] (408) 970-3950            | (408) 988-8000                   |
| Sprague               | [1] (603) 224-1430            | (603) 224-1961                   |
| Sumida                | [81] 3-3607-5144              | (847) 956-0666                   |

### Internal VL and REF Supplies

An internal linear regulator produces the 5V used by the internal control circuits. This regulator's output is available on pin VL and can source 5mA for external loads. Bypass VL to GND with 4.7 $\mu$ F. To save power, when the +5V switch-mode supply is above 4.5V, the internal linear regulator is turned off and the high-efficiency +5V switch-mode supply output is connected to VL.

The internal 3.3V bandgap reference (REF) is powered by the internal 5V VL supply. It can furnish up to 5mA. Bypass REF to GND with 0.22 $\mu$ F, plus  $1\mu$ F/mA of load

current. The main switching outputs track the reference voltage. Loading the reference will reduce the main outputs slightly, according to the reference load-regulation error.

Both the VL and REF outputs remain active, even when the switching regulators are turned off, to supply memory keep-alive power (see *Shutdown Mode* section).

These linear-regulator outputs can be directly connected to the corresponding step-down regulator outputs (i.e., REF to +3.3V, VL to +5V) to keep the main supplies alive in standby mode. However, to ensure start-up, standby load currents must not exceed 5mA on each supply.

#### Fault Protection

The +3.3V and +5V PWM supplies and the comparators are disabled when either of two faults is present: VL < +4.0V or REF < +2.8V (85% of its nominal value).

### Design Procedure

Figure 1's schematic and Table 2's component list show values suitable for a 3A, +5V supply and a 3A, +3.3V supply. This circuit operates with input voltages from 6.5V to 30V, and maintains high efficiency with output currents between 5mA and 3A (see the *Typical Operating Characteristics*). This circuit's components may be changed if the design guidelines described in this section are used—but before beginning the design, the following information should be firmly established:

**V<sub>IN(MAX)</sub>, the maximum input (battery) voltage.** This value should include the worst-case conditions under which the power supply is expected to function, such as no-load (standby) operation when a battery charger is connected but no battery is installed. V<sub>IN(MAX)</sub> cannot exceed 30V.

 $V_{IN(MIN)}$ , the minimum input (battery) voltage. This value should be taken at the full-load operating current under the lowest battery conditions. If  $V_{IN(MIN)}$  is below about 6.5V, the filter capacitance required to maintain good AC load regulation increases, and the current limit for the  $\pm 5V$  supply has to be increased for the same load level.

### Inductor (L1, L2)

Three inductor parameters are required: the inductance value (L), the peak inductor current ( $I_{LPEAK}$ ), and the coil resistance ( $R_L$ ). The inductance is:

$$L = \frac{(V_{OUT}) (V_{IN(MAX)} - V_{OUT})}{(V_{IN(MAX)}) (f) (I_{OUT}) (LIR)}$$

where:

V<sub>OUT</sub> = output voltage (3.3V or 5V); V<sub>IN(MAX)</sub> = maximum input voltage (V); f = switching frequency, normally 300kHz; I<sub>OUT</sub> = maximum DC load current (A); LIR = ratio of inductor peak-to-peak AC current to average DC load current, typically 0.3.

A higher value of LIR allows smaller inductance, but results in higher losses and higher ripple.

The highest peak inductor current ( $I_{LPEAK}$ ) equals the DC load current ( $I_{OUT}$ ) plus half the peak-to-peak AC inductor current ( $I_{LPP}$ ). The peak-to-peak AC inductor current is typically chosen as 30% of the maximum DC load current, so the peak inductor current is 1.15 times  $I_{OUT}$ .

The peak inductor current at full load is given by:

$$I_{LPEAK} = I_{OUT} + \frac{(V_{OUT}) (V_{IN(MAX)} - V_{OUT})}{(2) (f) (L) (V_{IN(MAX)})}$$

The coil resistance should be as low as possible, preferably in the low milliohms. The coil is effectively in series with the load at all times, so the wire losses alone are approximately:

Power loss = 
$$(I_{OUT}^2)$$
 (R<sub>L</sub>).

In general, select a standard inductor that meets the L,  $I_{LPEAK}$ , and  $R_{L}$  requirements (see Tables 1 and 2). If a standard inductor is unavailable, choose a core with an  $LI^{2}$  parameter greater than (L) ( $I_{LPEAK}^{2}$ ), and use the largest wire that will fit the core.

### Current-Sense Resistors (R1, R2)

The sense resistors must carry the peak current in the inductor, which exceeds the full DC load current. The internal current limiting starts when the voltage across the sense resistors exceeds 100mV nominally, 80mV minimum. Use the minimum value to ensure adequate output current capability: For the +3.3V supply, R1 = 80mV / (1.15 x  $I_{OUT}$ ); for the +5V supply, R2 = 80mV/(1.15 x  $I_{OUT}$ ), assuming that LIR = 0.3.

Since the sense resistance values (e.g., R1 =  $25m\Omega$  for  $I_{OUT}$  = 3A) are similar to a few centimeters of narrow traces on a printed circuit board, trace resistance can contribute significant errors. To prevent this, Kelvin connect the CS\_ and FB\_ pins to the sense resistors; i.e., use separate traces not carrying any of the inductor or load current, as shown in Figure 5.

Run these traces parallel at minimum spacing from one another. The wiring layout for these traces is critical for stable, low-ripple outputs (see the *Layout and Grounding* section).

### **MOSFET Switches (N1-N4)**

The four N-channel power MOSFETs are usually identical and must be "logic-level" FETs; that is, they must be fully on (have low  $r_{DS(ON)}$ ) with only 4V gatesource drive voltage. The MOSFET  $r_{DS(ON)}$  should ideally be about twice the value of the sense resistor. MOSFETs with even lower  $r_{DS(ON)}$  have higher gate capacitance, which increases switching time and transition losses.

MOSFETs with low gate-threshold voltage specifications (i.e., maximum  $V_{GS(TH)} = 2V$  rather than 3V) are preferred, especially for high-current (5A) applications.

### Output Filter Capacitors (C6, C7, C12)

The output filter capacitors determine the loop stability and output ripple voltage. To ensure stability, the minimum capacitance and maximum ESR values are:

$$C_F > \frac{V_{REF}}{(V_{OUT}) (R_{CS}) (2) (\pi) (GBWP)}$$

and,

$$\mathsf{ESR}_{\mathsf{CF}} < \frac{(\mathsf{V}_{\mathsf{OUT}}) \; (\mathsf{R}_{\mathsf{CS}})}{\mathsf{V}_{\mathsf{REF}}}$$

where:

 $C_F$  = output filter capacitance (F);

V<sub>REF</sub> = reference voltage, 3.3V; V<sub>OUT</sub> = output voltage, 3.3V or 5V;

 $R_{CS}$  = sense resistor ( $\Omega$ );

GBWP = gain-bandwidth product, 60kHz;  $ESR_{CF}$  = output filter capacitor ESR ( $\Omega$ ).

Be sure to select output capacitors that satisfy **both** the minimum capacitance and maximum ESR requirements. To achieve the low ESR required, it may be appropriate to use a capacitance value 2 or 3 times larger than the calculated minimum.

The output ripple in continuous-current mode is:

 $V_{OUT(RPL)} = I_{LPP(MAX)} \ x \ (ESR_{CF} + 1/(2 \ x \ \pi \ x \ f \ x \ C_F)$  ). In idle-mode, the ripple has a capacitive and resistive component:

$$\begin{split} V_{OUT(RPL)}(C) &= \frac{(4) (10^{-4}) (L)}{(R_{CS}^2) (C_F)} x \\ \left( \frac{1}{V_{OUT}} + \frac{1}{V_{IN} - V_{OUT}} \right) Volts \\ V_{OUT(RPL)}(R) &= \frac{(0.02) (ESR_{CF})}{R_{CS}} Volts \end{split}$$

The total ripple,  $V_{OUT(RPL)}$ , can be approximated as follows:

$$\begin{split} &\text{if} \quad V_{OUT(RPL)}(R) < 0.5 \; V_{OUT(RPL)}(C), \\ &\text{then} \quad V_{OUT(RPL)} = V_{OUT(RPL)}(C), \\ &\text{otherwise,} \quad V_{OUT(RPL)} = 0.5 \; V_{OUT(RPL)}(C) \; + \\ &\quad V_{OUT(RPL)}(R). \end{split}$$

#### Diodes D1 and D3

Use 1N5819s or similar Schottky diodes. D1 and D3 conduct only about 3% of the time, so the 1N5819's 1A current rating is conservative. The voltage rating of D1 and D3 must exceed the maximum input supply voltage from the battery. These diodes must be Schottky diodes to prevent the lossy MOSFET body diodes from turning on, and they must be placed physically close to their associated synchronous rectifier MOSFETs.

### Soft-Start Capacitors (C8, C9)

A capacitor connected from GND to either SS pin causes that supply to ramp up slowly. The ramp time to full current limit,  $t_{SS_i}$  is approximately 1ms for every nF of capacitance on SS\_, with a minimum value of 10 $\mu$ s. Typical capacitor values are in the 10nF to 100nF range; a 5V rating is sufficient.

Because this ramp is applied to the current-limit circuit, the actual time for the output voltage to ramp up depends on the load current and output capacitor value. Using Figure 1's circuit with a 2A load and no SS capacitor, full output voltage is reached about 600µs after ON\_ is driven high.

### **Boost Capacitors (C4, C5)**

Capacitors C4 and C5 store the boost voltage and provide the supply for the DH3 and DH5 drivers. Use  $0.1\mu F$  and place each within 10mm of the BST and LX pins.

### Boost Diodes (D1A, D1B)

Use high-speed signal diodes; e.g., 1N4148 or equivalent.

### **Bypass Capacitors**

### Input Filter Capacitors (C1, C10)

Use at least  $3\mu F/W$  of output power for the input filter capacitors, C1 and C10. They should have less than  $150m\Omega$  ESR, and should be located no further than 10mm from N1 and N2 to prevent ringing. Connect the negative terminals directly to PGND. Do not exceed the surge current ratings of input bypass capacitors.

#### Shutdown Mode

Shutdown (SHDN = low) forces both PWMs off and disables the REF output and both comparators (Q1 = Q2 = 0V). Supply current in shutdown mode is typically 25 $\mu$ A. The VL supply remains active and can source 25mA for external loads. Note that the VL load capability is higher in shutdown and standby modes than when the PWMs are operating (25mA vs. 5mA). Standby mode is achieved by holding ON3 and ON5 low while SHDN is high. This disables both PWMs, but keeps VL, REF, and the precision comparators alive. Supply current in standby mode is typically 70 $\mu$ A.

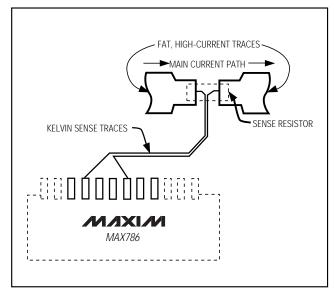


Figure 5. Kelvin Connections for the Current-Sense Resistors

Table 3. EV Kit Power-Supply Controls (SW1)

| SWITCH | NAME | FUNCTION                    | ON<br>SETTING | OFF<br>SETTING |
|--------|------|-----------------------------|---------------|----------------|
| 1      | SHDN | Enable shutdown mode        | Operate       | Shutdown       |
| 2      | ON3  | Enable 3.3V<br>power supply | 3.3V ON       | 3.3V OFF       |
| 3      | ON5  | Enable 5.0V<br>power supply | 5V ON         | 5V OFF         |
| 4      | SYNC | Oscillator                  | 200kHz        | 300kHz         |

Other ways to shut down the MAX786 are suggested in the applications section of the MAX782/MAX783 data sheet.

### \_Applications Information

### Low-Voltage (6-Cell) Operation

The standard application circuit can be configured to accept input voltages from 5.5V to 12V by changing the oscillator frequency to 200kHz and increasing the +5V filter capacitor to 660µF. This allows stable operation at 5V loads up to 2A (the 3.3V side requires no changes and still delivers 3A).

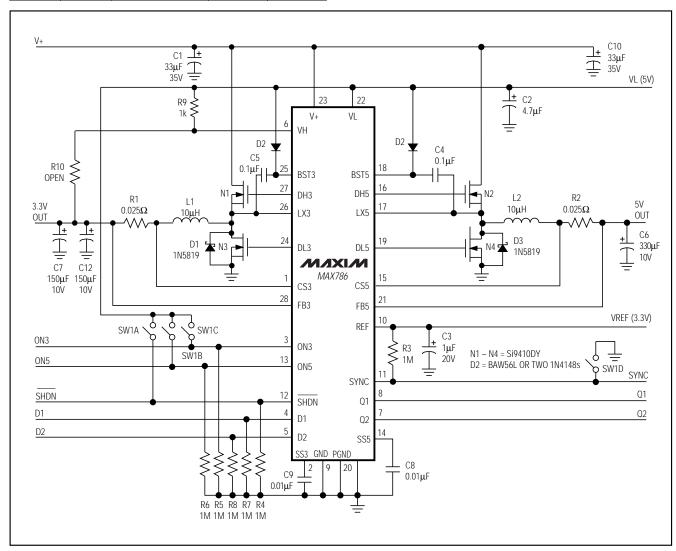


Figure 6. MAX786 EV Kit Schematic

### **EV Kit Information**

The MAX786 evaluation kit (EV kit) embodies the standard application circuit, with some extra pull-up and pull-down resistors needed to set default logic signal levels. The board comes configured to accept battery input voltages between 6.5V and 30V, and provides up to 25W of output power. All functions are con-

trolled by standard CMOS/TTL logic levels or DIP switches. The kit can be reconfigured for lower battery voltages by setting the oscillator to 200kHz and increasing the 5V output filter capacitor value.

The D1 and D2 comparators can be used as precision voltage detectors by installing resistor dividers at each input.

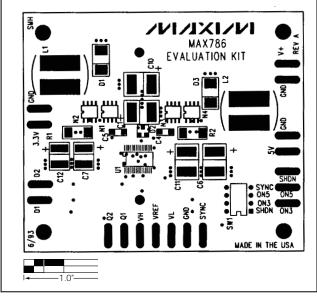


Figure 7. MAX786 EV Kit Top Component Layout and Silk Screen, Top View

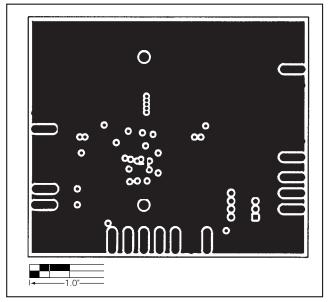


Figure 8. MAX786 EV Kit Ground Plane (Layers 2 and 3), Top View

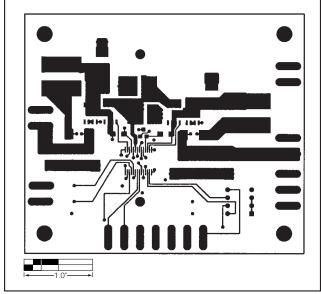


Figure 9. MAX786 EV Kit Top Layer (Layer 1), Top View

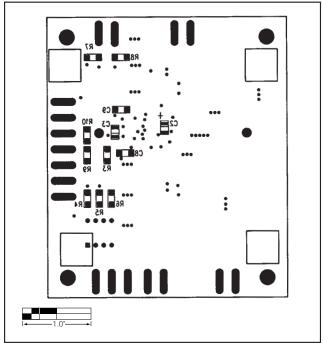


Figure 10. MAX786 EV Kit, Bottom Component Layout and Silk Screen, Bottom View

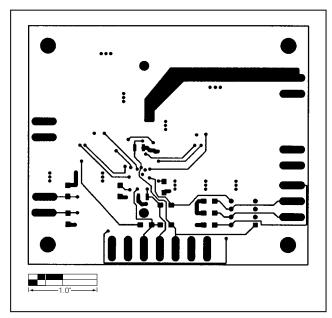
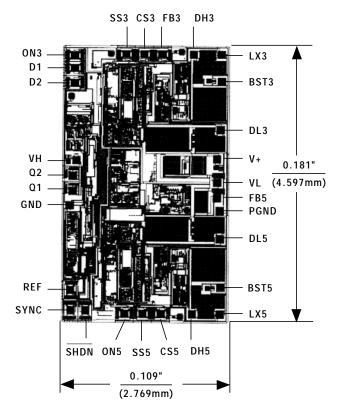


Figure 11. MAX786 EV Kit, Bottom Layer (Layer 4), Top View

### Chip Topography



TRANSISTOR COUNT: 1294 SUBSTRATE CONNECTED TO GND

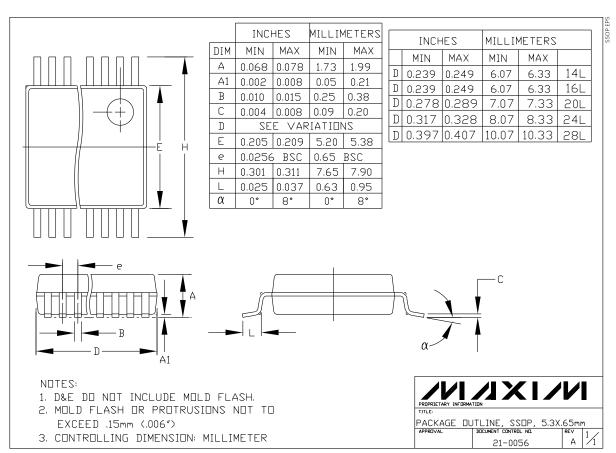
### \_Ordering Information (continued)

| PART       | TEMP. RANGE    | PIN-PACKAGE | Vout  |
|------------|----------------|-------------|-------|
| MAX786SCAI | 0°C to +70°C   | 28 SSOP     | 3.6V  |
| MAX786C/D  | 0°C to +70°C   | Dice*       | _     |
| MAX786EAI  | -40°C to +85°C | 28 SSOP     | 3.3V  |
| MAX786REAI | -40°C to +85°C | 28 SSOP     | 3.45V |
| MAX786SEAI | -40°C to +85°C | 28 SSOP     | 3.6V  |

| EV KIT         | TEMP. RANGE  | <b>BOARD TYPE</b> |
|----------------|--------------|-------------------|
| MAX786EVKIT-SO | 0°C to +70°C | Surface Mount     |

<sup>\*</sup>Contact factory for dice specifications.

### Package Information



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NCP81206MNTXG NX2155HCUPTR UBA2051C MAX8778ETJ+ NTBV30N20T4G NCP1240AD065R2G NCP1240FD065R2G

NCP1361BABAYSNT1G NTC6600NF TC105333ECTTR NCP1230P100G NCP1612BDR2G NX2124CSTR SG2845M

NCP81101MNTXG IFX81481ELV NCP81174NMNTXG NCP4308DMTTWG NCP4308DMNTWG NCP4308AMTTWG

NCP1251FSN65T1G NCP1246BLD065R2G NTE7154 NTE7242 LTC7852IUFD-1#PBF LTC7852EUFD-1#PBF MB39A136PFT-G-BND-ERE1 NCP1256BSN100T1G LV5768V-A-TLM-E NCP1365BABCYDR2G NCP1365AABCYDR2G MCP1633T-E/MG NCV1397ADR2G

AZ494AP-E1 UTC3843D XDPL8219XUMA1